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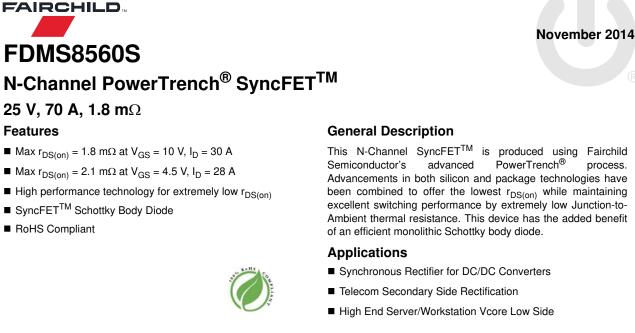
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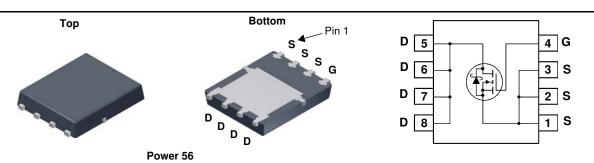


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MOSFET Maximum Ratings $T_A = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter			Ratings	Units		
V _{DS}	Drain to Source Voltage			25	V		
V _{GS}	Gate to Source Voltage			12	V		
	Drain Current -Continuous (Package limited)	T _C = 25 °C		70			
ID	-Continuous	T _A = 25 °C	(Note 1a)	30	Α		
	-Pulsed			150			
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	79	mJ		
P _D	Power Dissipation	T _C = 25 °C		65			
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5			
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C		

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	T _C = 25 °C		1.9	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	T _A = 25 °C	(Note 1a)	50	C/ VV

Package Marking and Ordering Information

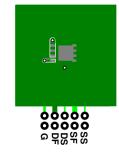
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
05OD	FDMS8560S	Power 56	13"	12 mm	3000 units

process.

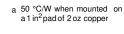
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	cteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 1 mA, V _{GS} = 0 V	25			V	
ΔBV_{DSS} ΔT_J	Breakdown Voltage Temperature Coefficient	$I_D = 10 \text{ mA}$, referenced to 25 °C		20		mV/°C	
IDSS	Zero Gate Voltage Drain Current	$V_{DS} = 20 V, V_{GS} = 0 V$			500	μA	
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = +12 \text{ V}/-8 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			±100	nA	
On Chara	cteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 1 \text{ mA}$	1.1	1.4	2.2	V	
$\Delta V_{GS(th)}$ ΔT_J	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 10 \text{ mA}$, referenced to 25 °C		-3		mV/°C	
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 30 A		1.4	1.8	mΩ	
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 28 \text{ A}$		1.6	2.1		
		V_{GS} = 10 V, I _D = 30 A, T _J = 125 °C		2.1	2.8		
9fs	Forward Transconductance	$V_{DS} = 5 \text{ V}, \text{ I}_{D} = 30 \text{ A}$		304		S	
Dynamic C _{iss}	Characteristics			4350		pF	
C _{oss}	Output Capacitance	$-V_{DS} = 13 V, V_{GS} = 0 V,$		1270		pF	
C _{rss}	Reverse Transfer Capacitance	f = 1 MHz		138		pF	
R _q	Gate Resistance			0.8		Ω	
Switching	Characteristics						
t _{d(on)}	Turn-On Delay Time			13		ns	
t _r	Rise Time	V _{DD} = 13 V, I _D = 30 A,		6		ns	
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		45		ns	
t _f	Fall Time			5		ns	
Qg	Total Gate Charge	V _{GS} = 0 V to 10 V		68		nC	
Qg	Total Gate Charge	$V_{GS} = 0 V \text{ to } 4.5 V V_{DD} = 13 V,$		32		nC	
Q _{gs}	Gate to Source Gate Charge	I _D = 30 A		8.2		nC	
Q _{gd}	Gate to Drain "Miller" Charge			9.6		nC	
Drain-Sou	urce Diode Characteristics						
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2 A$ (Note 2)		0.6	0.8	v	
▼SD		$V_{GS} = 0 V, I_S = 30 A$ (Note 2)		0.8	1.2	v	
t _{rr}	Reverse Recovery Time	— I _F = 30 A, di/dt = 300 A/μs		32		ns	
Qrr	Reverse Recovery Charge	$r_{\rm F} = 00 \text{A}, 0.001 = 000 \text{A} \mu \text{B}$		41		nC	

Q_{rr} NOTES:

1. R_{0,J,C} is determined with the device mounted on a FR-4 board using a specified pad of 2 oz copper as shown below. R_{0,JC} is guaranteed by design while R_{0CA} is determined by the user's board design.



Reverse Recovery Charge





b 125 °C/W when mounted on a minimum pad of 2 oz copper.

41

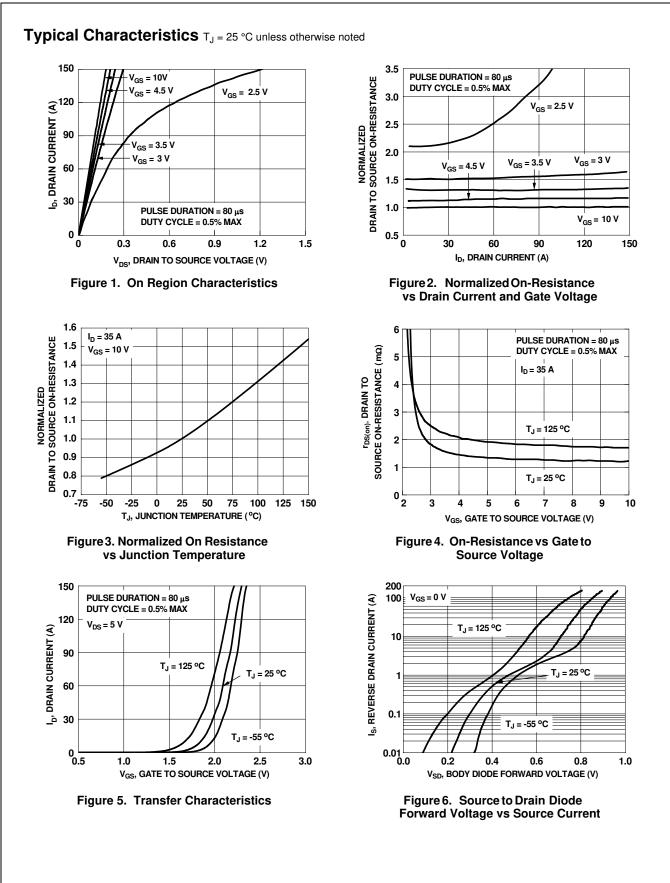
2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.

3. E_{AS} of 79 mJ is based on starting T_J = 25 °C, L = 2.5 mH, I_{AS} = 8 A, V_{DD} = 23 V, V_{GS} = 10 V. 100% test at L = 0.1 mH, I_{AS} = 33.7 A.

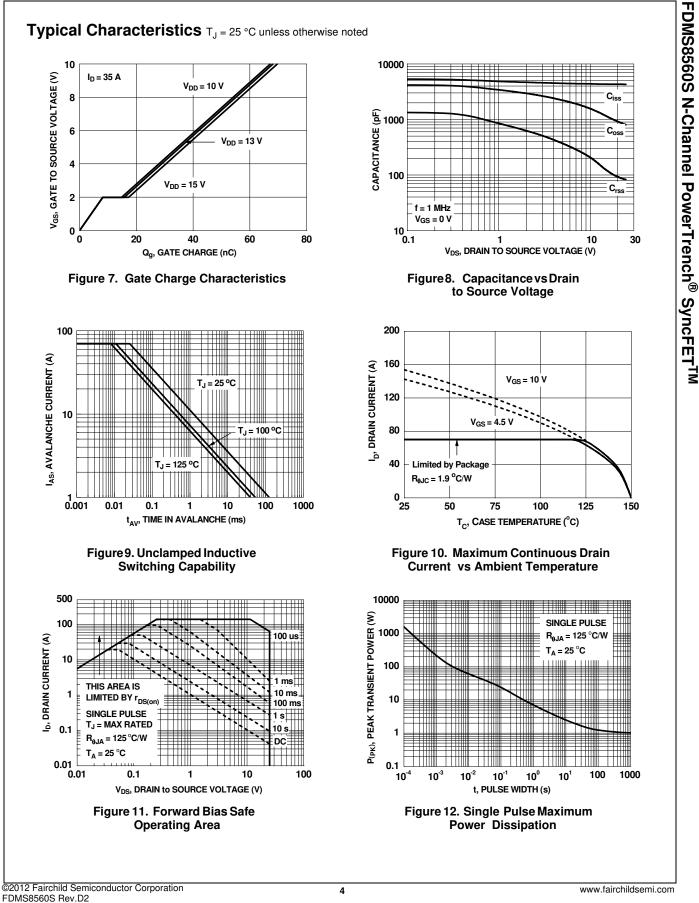
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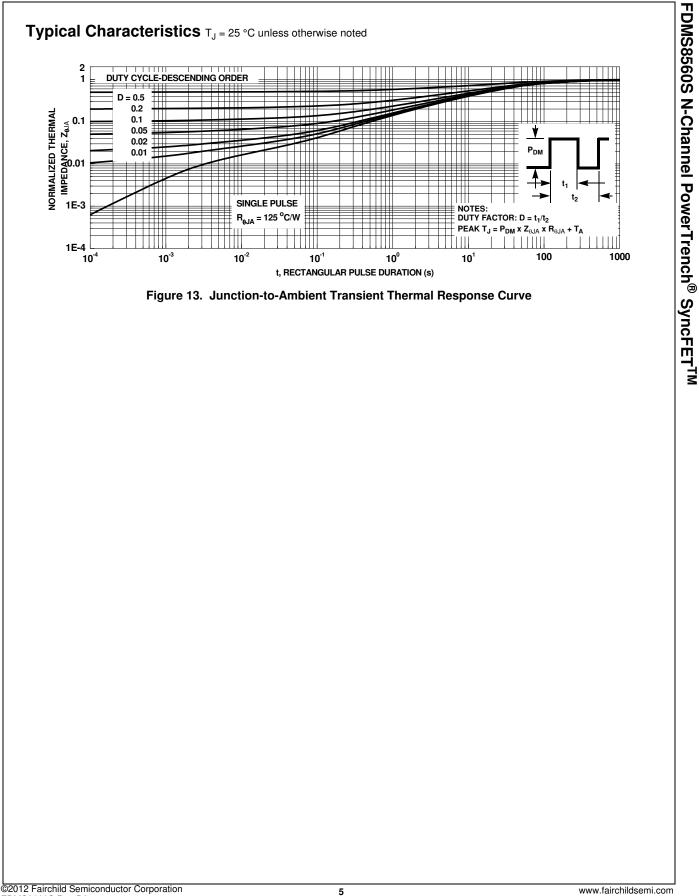
FDMS8560S N-Channel PowerTrench[®] SyncFETTM

FDMS8560S N-Channel PowerTrench[®] SyncFETTM



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FDMS8560S Rev.D2

FDMS8560S N-Channel PowerTrench[®] SyncFETTM

Typical Characteristics (continued)

SyncFET[™] Schottky body diode Characteristics

Fairchild's SyncFETTM process embeds a Schottky diode in parallel with PowerTrench MOSFET. This diode exhibits similar characteristics to a discrete external Schottky diode in parallel with a MOSFET. Figure 14 shows the reverse recovery characteristic of the FDMS8560S.

Schottky barrier diodes exhibit significant leakage at high temperature and high reverse voltage. This will increase the power in the device.

T_{.1} = 125 °C

T_J = 100 °C

T_J = 25 °C

15

20

25

10⁻²

10⁻³

10⁻⁴

10⁻⁵

10⁻⁶

0

I_{DSS}, REVERSE LEAKAGE CURRENT (A)

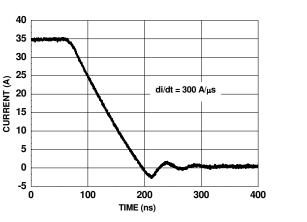


Figure 14. FDMS8560S SyncFETTM body diode reverse recovery characteristic

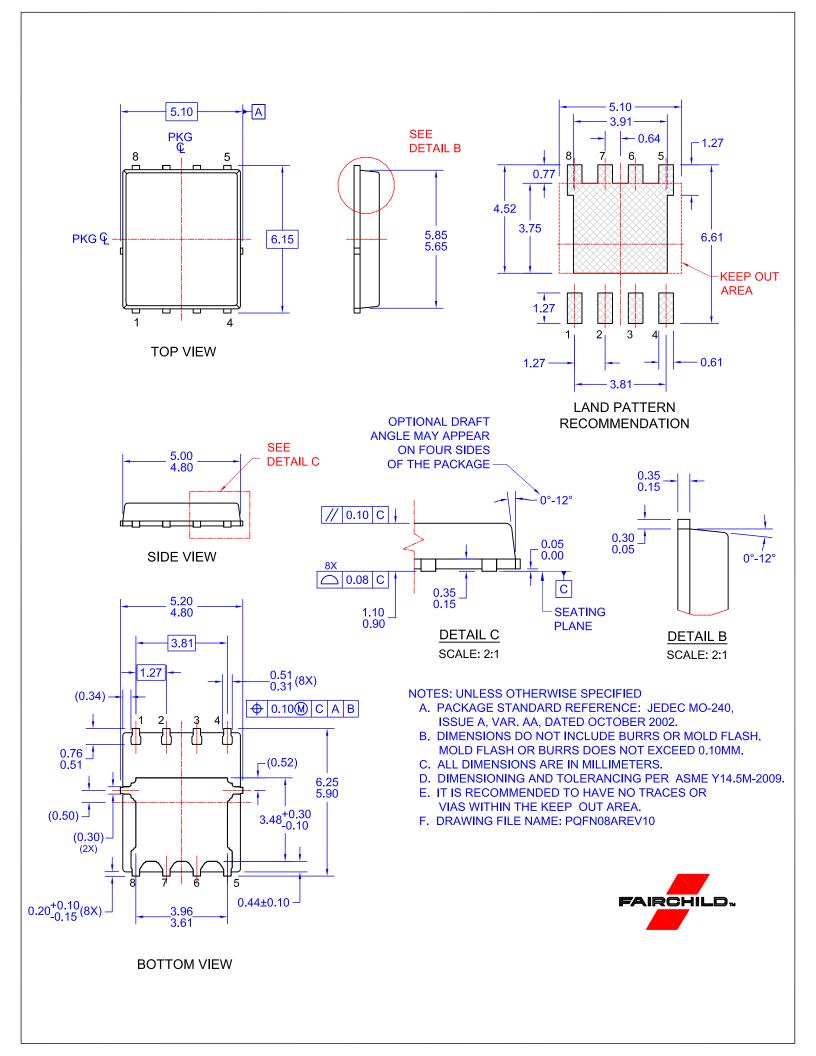
Figure 15. SyncFETTM body diode reverse leakage versus drain-source voltage

V_{DS}, REVERSE VOLTAGE (V)

10

5

6



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